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January 2007

FDY3000NZ

Dual N-Channel 2.5V Specified PowerTrench® MOSFET

General Description

This Dual N-Channel MOSFET has been designed using Fairchild Semiconductor's advanced Power Trench process to optimize the $R_{\text{DS(ON)}} \textcircled{Q} \ V_{\text{GS}} = 2.5 \text{v}.$

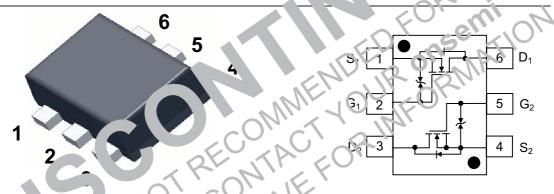
Applications

• Li-Ion Battery Pack



Features

- 600 mA, 20 V $R_{DS(ON)} = 700$ r @ V_{GS} 4.5 V $R_{DS(ON)} = 700$ ms. 7 $V_{GS} = .5$ V
- ESD protection diode of:
- RoHS Conliant



hs 'ut "aximum Ratings TA=25° Unles otherwise noted

	Sy.	por	Parameter		Ratings	Units
	$\overline{\Lambda}^{D_{\mathbf{u}}}$	\bot	Dirain-Source Voltage		20	V
	GSS		Gate-Source Vollage		± 12	V
	ID	∇	Drain C rrent — Cจาน่านอนร	(Note 1a)	600	mA
<	$\supset Y$		- Fulsed		1000	
. 1	C _D		Power Dissipation (Steady State)	(Note 1a)	625	mW
) ₋			20	(Note 1b)	446	
	T _J , T ₃	STG	Operating and Storage Junction Temporal Range	erature	–55 to +150	°C

Thermal Characteristics

$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient (Note 1a)	200	°C/W
Rola	Thermal Resistance, Junction-to-Ambient (Note 1b)	280	

Package Marking and Ordering Information

Device Marking	Device	Reel Size	Tape width	Quantity
С	FDY3000NZ	7 "	8 mm	3000 units

Symbol	Parameter	Test Conditions	Min	Тур	Max	Units
Off Char	acteristics		•	•		
BV _{DSS}	Drain–Source Breakdown Voltage	$V_{GS} = 0 \text{ V}, \qquad I_{D} = 250 \mu\text{A}$	20			V
<u>ΔBV_{DSS}</u> ΔΤ _J	Breakdown Voltage Temperature Coefficient	I _D = 250 μA, Referenced to 25°C		14		mV/°C
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} = 16 V, V _{GS} = 0 V			1	μΑ
I_{GSS}	Gate-Body Leakage,	$V_{GS} = \pm 12 \text{ V}, V_{DS} = 0 \text{ V}$			± 10	μΑ
		$V_{GS} = \pm 4.5 \text{ V}, V_{DS} = 0 \text{ V}$		<u> </u>		μΑ
On Char	acteristics (Note 2)			4		
$V_{GS(th)}$	Gate Threshold Voltage	$V_{DS} = V_{GS}$, $I_D = 250 \mu A$	0	1.0	1.3	V,
$\frac{\Delta V_{GS(th)}}{\Delta T_J}$	Gate Threshold Voltage Temperature Coefficient	I_D = 250 μA, Referenced to 25°C		3		m\//°(
$R_{\text{DS(on)}}$	Static Drain-Source	$V_{GS} = 4.5 \text{ V}, I_{D} = 600 \text{ mA}$.5	0.70	Ω
	On–Resistance	$V_{GS} = 2.5 \text{ V}, I_D = 500 \text{ nA}$ $V_{GS} = 1.8 \text{ V}, I_D = 150 \text{ A}$		0.37 0.73	າ 55 1.25	
		$V_{GS} = 4.5 \text{ V}, I_D = 0.00 \text{ A. T.}$ 125		0.75	1.00	
g _{FS}	Forward Transconductance	V _{DS} = 5 V, I _D .		1.8		S
Dynamic	Characteristics		60		<i>U</i> 1,	10
C _{iss}	Input Capacitance	$V_{DS} = 1$, $V_{C} = 0 V$,		C		pr
Coss	Output Capacitance	1.0 MF.		20		pF
C _{rss}	Reverse Transfer Capacitan	NV.		10		pF
Switchin	g Characteristic (NC)	ME, OU	1	1/~.		
t _{d(on)}	Turn-On Delay T e	$V_{DD} = 10 \text{ V}, I_D = 1 \text{ A}$	16	6	12	ns
t _r	Turn-Or Tim	$V_{GS} = 4.5 \text{ V}, P_{GLN} = 6 \Omega$	12.	8	16	ns
$t_{d(off)}$	Turn-(Delay Time	C'AR'		8	16	ns
t _f	i–C Fall Tir	14 50,		2.4	4.8	ns
Qg	To atege	$V_{LS} = .0 \text{ V}, I_{\Gamma} = 600 \text{ mA},$		0.8	1.1	nC
Q _{gs}	Gate- Jurce Charge	$V_{G_3} = 4.5 \text{ V}$		0.16		nC
<u>~</u>	-Drain Charge			0.26		nC
	Jurce Diode Characteristics	and Maximum Ratings				
V _{SP}	Drain-Source Ding + Forward	V _{GS} = 0 V, I _S = 150 mA (Note 2)		0.7	1.2	V
.3	Voltage		1			
t _{rr}	Diode Feverce Recovery Time	$I_F = 600 \text{ mA},$ $dI_F/dt = 100 \text{ A}/\mu\text{s}$		8		nS

Notes:

1. R_{0,IA} is the sum of the junction to-case and case-to-ambient thermal resistance where the case thermal reference is defined as the solder mounting surface of the drain pins. R_{0,IC} is go an ante-ord by design while R_{0,CA} is determined by the user's board design



200°C/W when mounted on a 1in² pad of 2 oz copper



- b) 280°C/W when mounted on a minimum pad of 2 oz copper Scale 1 : 1 on letter size paper
- 2. Pulse Test: Pulse Width < $300\mu s$, Duty Cycle < 2.0%
- The diode connected between the gate and source serves only as protection againts ESD. No gate overvoltage rating is implied.

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Typical Characteristics

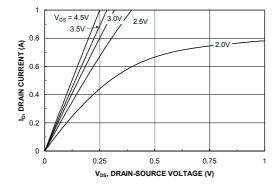


Figure 1. On-Region Characteristics.

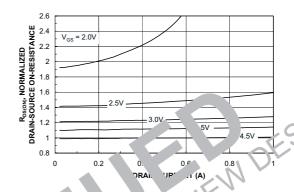
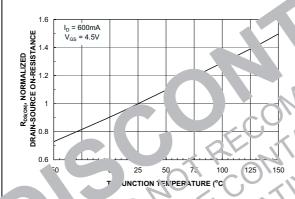


Figure 1. O. 35 stance Variation with Current and Gale Voltage.



igu 3. On-Resistance ປະຕິວະໄດກ with Temperature

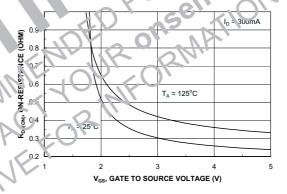


Figure 4. On-Resistance Variation with Gate-to-Source Voltage.

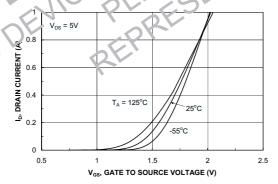


Figure 5. Transfer Characteristics.

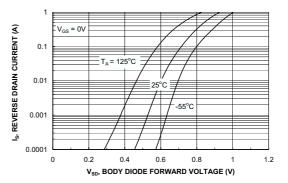
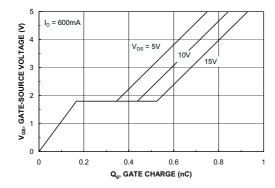


Figure 6. Body Diode Forward Voltage Variation with Source Current and Temperature.

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Typical Characteristics



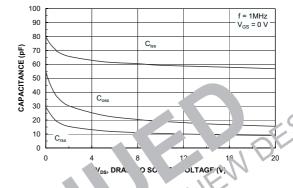
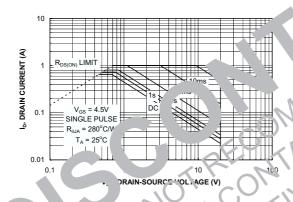
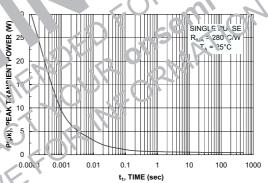


Figure 7. Gate Charge Characteristics.







Tig∟ ∖ 9. ...aximum Sate Operating Area

Figure 10. Single Pulse Maximum Power Dissipation.

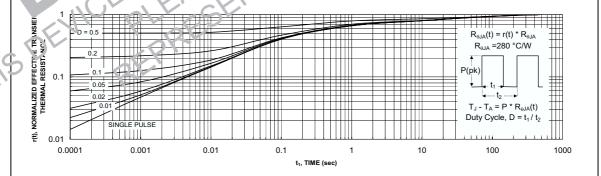
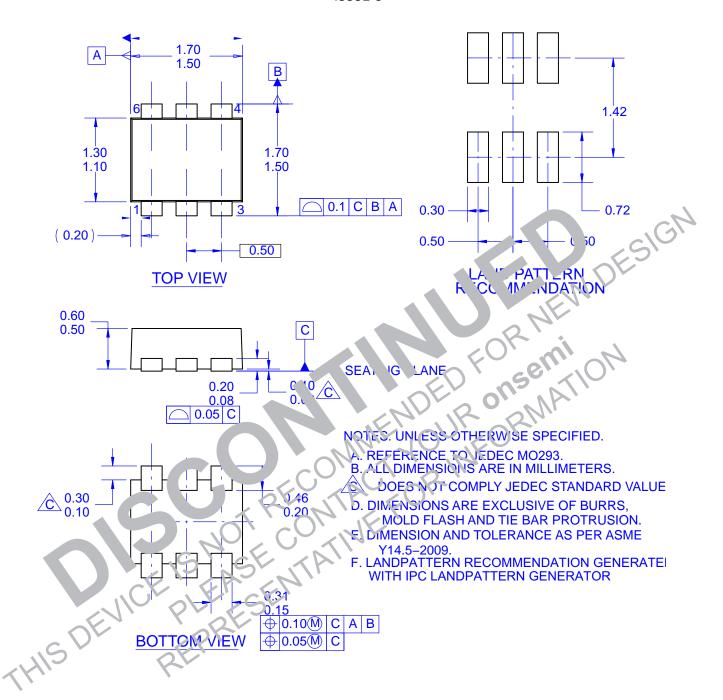


Figure 11. Transient Thermal Response Curve.

Thermal characterization performed using the conditions described in Note 1b. Transient thermal response will change depending on the circuit board design.

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